

SMC850 (SMC850N) High Performance infrared SMD LED on ceramics

SMC850 consists of an AlGaAs LED mounted on the ceramics package

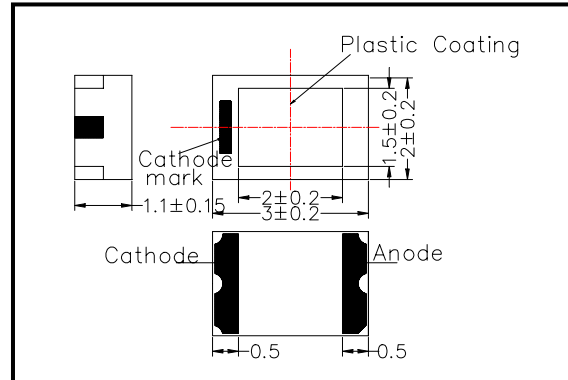
and is 38mW typical of output power.

It emits a spectral band of radiation at 850nm and is sealed with silicone or epoxy resin.

◆ Specifications

1) Product Name	Ceramics SMD IRED
2) Type No.	SMC850
3) Chip	
(1) Chip Material	AlGaAs
(2) Chip Dimension	0.4mm*0.4mm
(3) Peak Wavelength	850nm typ.
4) Package	
(1) Package	Ceramics
(2) Lens	Silicone or Epoxy resin

◆ Outer dimension (Unit: mm)



◆ Absolute Maximum Rating

Item	Symbol	Maximum Rated Value	Unit	Ambient Temperature
Power Dissipation	P _D	160	mW	T _a =25°C
Forward Current	I _F	100	mA	T _a =25°C
Pulse Forward Current	I _{FP}	1,000	mA	T _a =25°C
Reverse Voltage	V _R	5	V	T _a =25°C
Junction Temperature	T _J	100	°C	
Thermal Resistance	R _{thja}	190	K/W	
Operating Temperature	T _{OPR}	-20 ~ +80	°C	
Storage Temperature	T _{STG}	-30 ~ +80	°C	
Soldering Temperature	T _{SOL}	255	°C	

‡Pulse Forward Current condition: Duty=1% and Pulse Width=10us.

‡Soldering condition: Soldering condition must be completed within 10 seconds at 255°C

◆ Electro-Optical Characteristics [T_a=25°C]

Item	Symbol	Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V _F	I _F =50mA DC		1.45	1.60	V
		I _F =100mA, t _p =20ms		1.50	1.8	
Reverse Current	I _R	V _R =5V			10	uA
Total Radiated Power	P _O	I _F =50mA DC	15.0	19.0		mW
		I _F =100mA, t _p =20ms		38.0		
Radiant Intensity	I _E	I _F =50mA DC		10		mW/sr
		I _F =100mA, t _p =20ms		20		
Peak Wavelength	λ _P	I _F =50mA DC		850		nm
Half Width	Δλ	I _F =50mA DC		40		nm
Viewing Half Angle	θ _{1/2}	I _F =50mA DC		±55		deg.
Rise Time	t _r	I _F =50mA DC		15		ns
Fall Time	t _f	I _F =50mA DC		10		ns

‡Total Radiated Power is measured by Photodyne #500

‡Radiant Intensity is measured by Tektronix J-6512.